



## P-Channel Enhancement-Mode Vertical DMOS FET

### Features

- ▶ Low threshold (-2.4V max.)
- ▶ High input impedance
- ▶ Low input capacitance (80pF typ.)
- ▶ Fast switching speeds
- ▶ Low on-resistance
- ▶ Free from secondary breakdown
- ▶ Low input and output leakage

### Applications

- ▶ Logic level interfaces – ideal for TTL and CMOS
- ▶ Solid state relays
- ▶ Battery operated systems
- ▶ Photo voltaic drives
- ▶ Analog switches
- ▶ General purpose line drivers
- ▶ Telecom switches

### General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex’s well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex’s vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Ordering Information

| Device | Package    | Wafer / Die Options       |                              |                           |
|--------|------------|---------------------------|------------------------------|---------------------------|
|        | TO-92      | NW<br>(Die in wafer form) | NJ<br>(Die on adhesive tape) | ND<br>(Die in wafer pack) |
| TP0606 | TP0606N3-G | TP2506NW                  | TP2506NJ                     | TP2506ND                  |

*For packaged products, -G indicates package is RoHS compliant ('Green'). Devices in Wafer / Die form are RoHS compliant ('Green'). Refer to Die Specification VF25 for layout and dimensions.*

### Product Summary

| Device     | $BV_{DSS}/BV_{DGS}$<br>(V) | $R_{DS(ON)}$<br>(max)<br>( $\Omega$ ) | $I_{D(ON)}$<br>(min)<br>(A) | $V_{GS(th)}$<br>(max)<br>(V) |
|------------|----------------------------|---------------------------------------|-----------------------------|------------------------------|
| TP0606N3-G | -60                        | 3.5                                   | -1.5                        | -2.4                         |

### Absolute Maximum Ratings

| Parameter                         | Value                             |
|-----------------------------------|-----------------------------------|
| Drain-to-source voltage           | $BV_{DSS}$                        |
| Drain-to-gate voltage             | $BV_{DGS}$                        |
| Gate-to-source voltage            | $\pm 20V$                         |
| Operating and storage temperature | $-55^{\circ}C$ to $+150^{\circ}C$ |

*Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.*

### Pin Configuration



### Product Marking



YY = Year Sealed  
 WW = Week Sealed  
 \_\_\_\_\_ = "Green" Packaging

*Package may or may not include the following marks: Si or*

**TO-92 (N3)**

## Thermal Characteristics

| Package | $I_D$<br>(continuous) <sup>†</sup><br>(mA) | $I_D$<br>(pulsed)<br>(A) | Power Dissipation<br>@ $T_c = 25^\circ\text{C}$<br>(W) | $\theta_{jc}$<br>( $^\circ\text{C/W}$ ) | $\theta_{ja}$<br>( $^\circ\text{C/W}$ ) | $I_{DR}$ <sup>†</sup><br>(mA) | $I_{DRM}$<br>(A) |
|---------|--|--------------------------|--|---|---|-------------------------------|------------------|
| TO-92   | 320  | -3.5                     | 1.0  | 125                                     | 170                                     | 320                           | -3.5             |

**Notes:**

<sup>†</sup>  $I_D$  (continuous) is limited by max rated  $T_j$ .

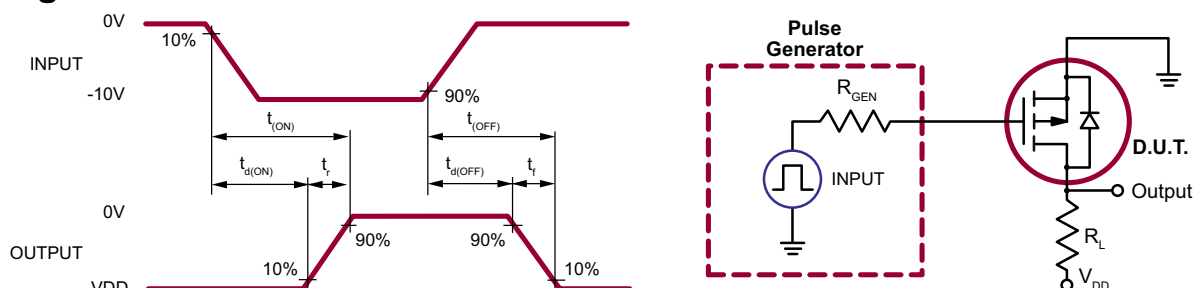
## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

| Sym                 | Parameter                                  | Min  | Typ  | Max  | Units                | Conditions  |
|---------------------|--|------|------|------|----------------------|---|
| $BV_{DSS}$          | Drain-to-source breakdown voltage          | -60  | -    | -    | V                    | $V_{GS} = 0V, I_D = -2.0mA$   |
| $V_{GS(th)}$        | Gate threshold voltage                     | -1.0 | -    | -2.4 | V                    | $V_{GS} = V_{DS}, I_D = -1.0mA$   |
| $\Delta V_{GS(th)}$ | Change in $V_{GS(th)}$ with temperature    | -    | -    | -5.0 | mV/ $^\circ\text{C}$ | $V_{GS} = V_{DS}, I_D = -1.0mA$   |
| $I_{GSS}$           | Gate body leakage                          | -    | -    | -100 | nA                   | $V_{GS} = \pm 20V, V_{DS} = 0V$   |
| $I_{DSS}$           | Zero gate voltage drain current            | -    | -    | -10  | $\mu\text{A}$        | $V_{GS} = 0V, V_{DS} = \text{Max Rating}$                               |
|                     |  | -    | -    | -1.0 | mA                   | $V_{DS} = 0.8 \text{ Max Rating}, V_{GS} = 0V, T_A = 125^\circ\text{C}$ |
| $I_{D(ON)}$         | ON-state drain current                     | -0.4 | -0.6 | -    | A                    | $V_{GS} = -5.0V, V_{DS} = -25V$   |
|                     |  | -1.5 | -2.5 | -    |                      | $V_{GS} = -10V, V_{DS} = -25V$  |
| $R_{DS(ON)}$        | Static drain-to-source on-state resistance | -    | 5.0  | 7.0  | $\Omega$             | $V_{GS} = -5.0V, I_D = -250mA$  |
|                     |  | -    | 3.0  | 3.5  |                      | $V_{GS} = -10V, I_D = -750mA$   |
| $\Delta R_{DS(ON)}$ | Change in $R_{DS(ON)}$ with temperature    | -    | -    | 1.7  | %/ $^\circ\text{C}$  | $V_{GS} = -10V, I_D = -750mA$   |
| $G_{FS}$            | Forward transductance                      | 300  | 400  | -    | mmho                 | $V_{DS} = -25V, I_D = -750mA$   |
| $C_{ISS}$           | Input capacitance                          | -    | 80   | 150  | pF                   | $V_{GS} = 0V, V_{DS} = -25V, f = 1.0MHz$                                |
| $C_{OSS}$           | Common source output capacitance           | -    | 50   | 85   |                      |   |
| $C_{RSS}$           | Reverse transfer capacitance               | -    | 15   | 35   |                      |   |
| $t_{d(ON)}$         | Turn-on delay time                         | -    | -    | 10   | ns                   | $V_{DD} = -25V, I_D = -1.0A, R_{GEN} = 25\Omega$                        |
| $t_r$               | Rise time                                  | -    | -    | 15   |                      |   |
| $t_{d(OFF)}$        | Turn-off delay time                        | -    | -    | 20   |                      |   |
| $t_f$               | Fall time                                  | -    | -    | 15   |                      |   |
| $V_{SD}$            | Diode forward voltage drop                 | -    | -    | -1.8 | V                    | $V_{GS} = 0V, I_{SD} = -1.0A$   |
| $t_{tr}$            | Reverse recovery time                      | -    | 300  | -    | ns                   | $V_{GS} = 0V, I_{SD} = -1.0A$   |

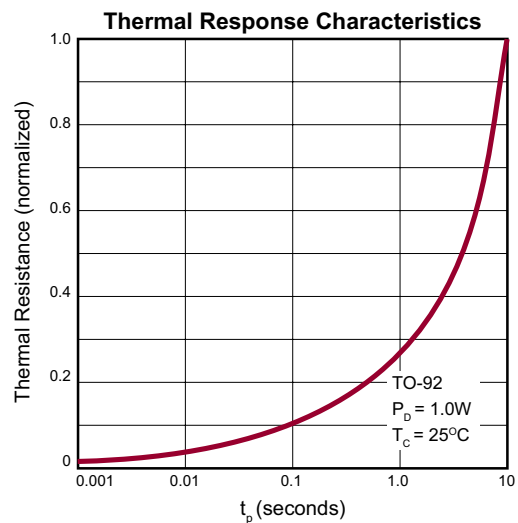
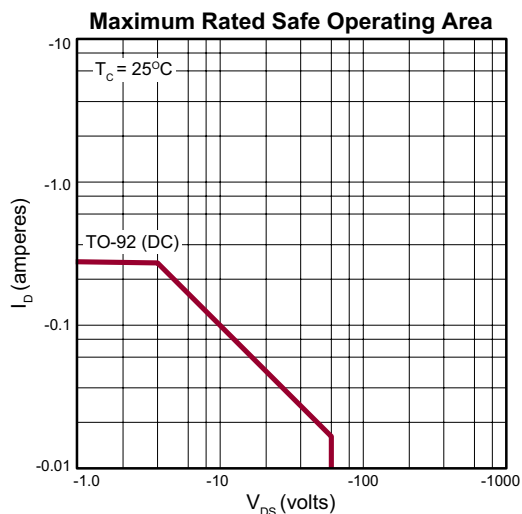
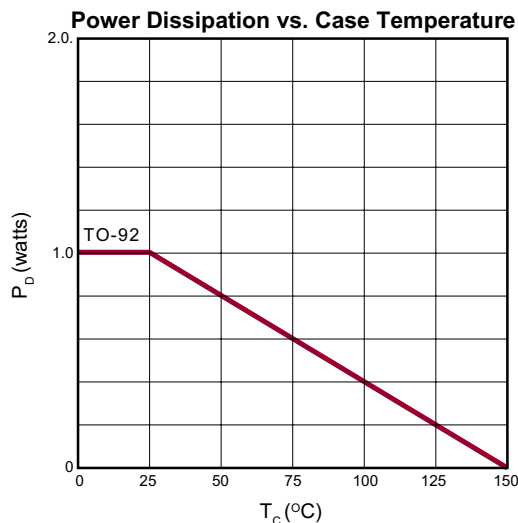
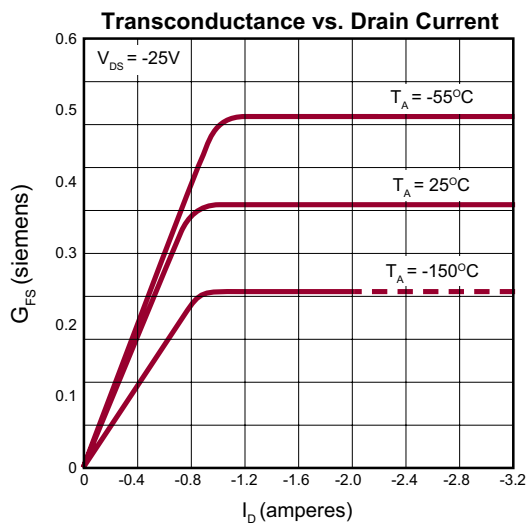
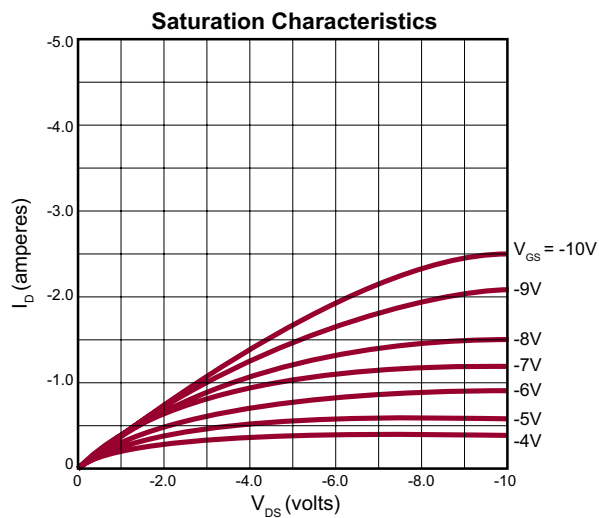
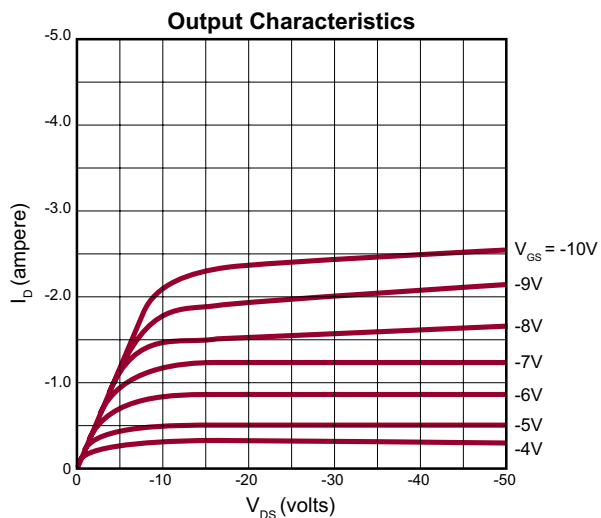
**Notes:**

- All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

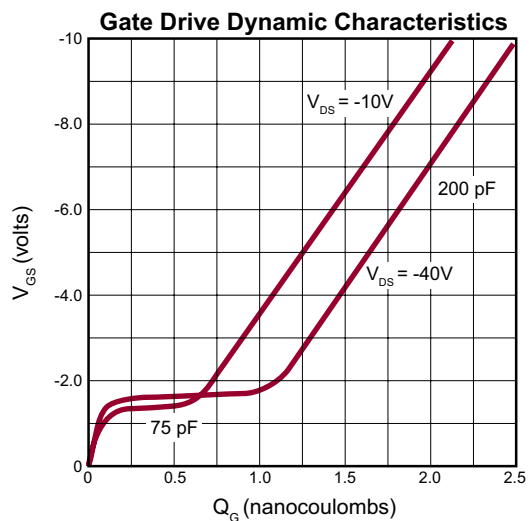
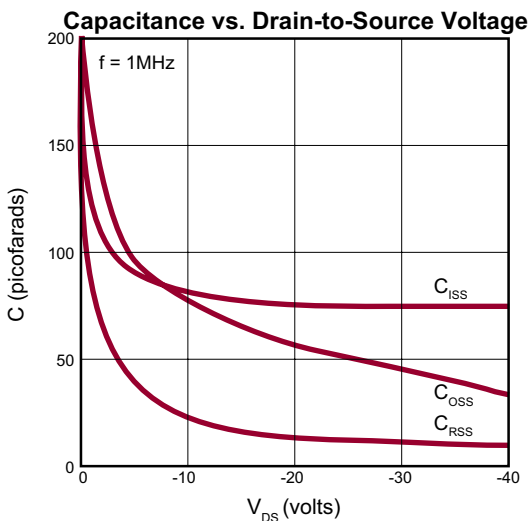
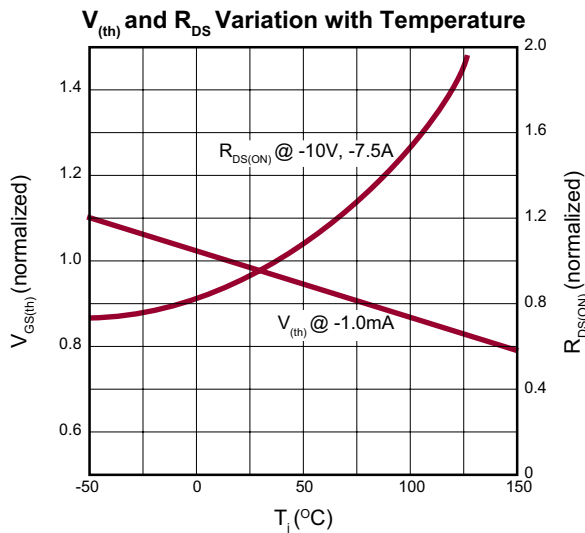
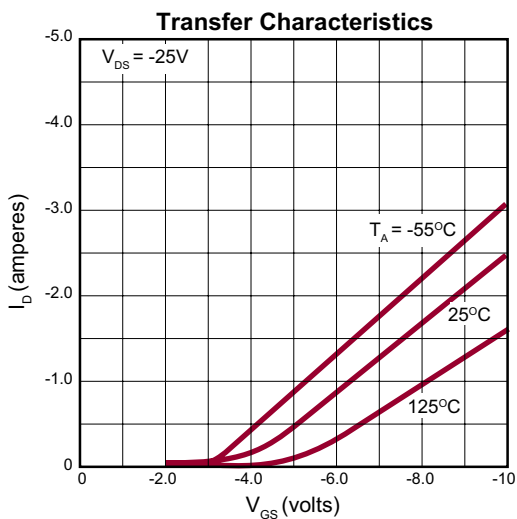
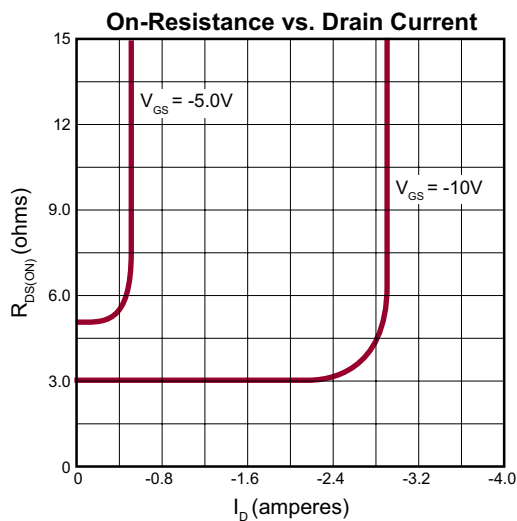
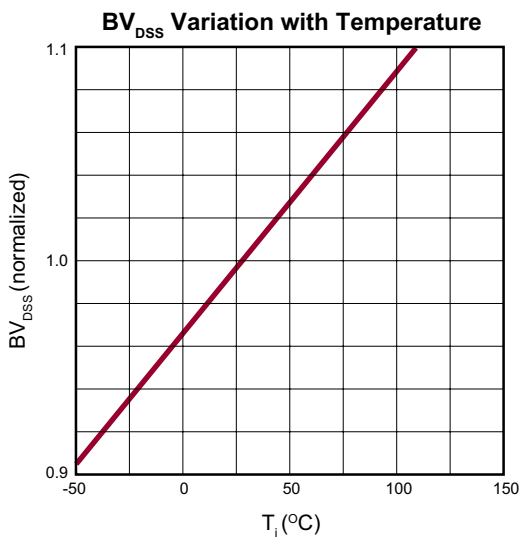
## Switching Waveforms and Test Circuit



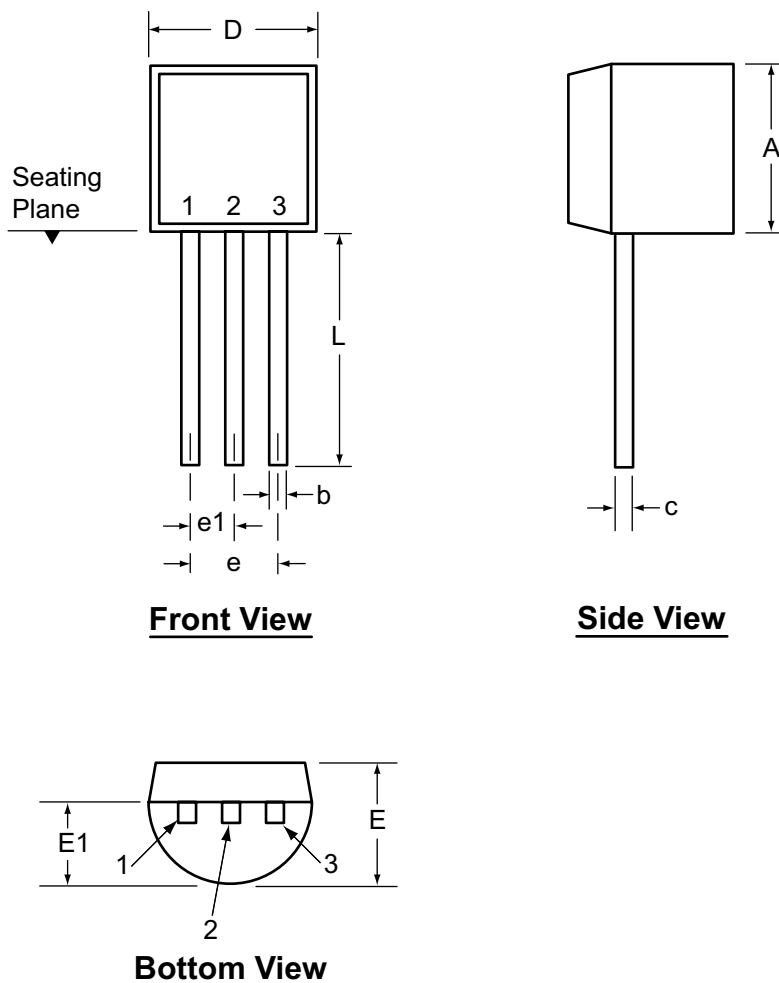
## Typical Performance Curves



Typical Performance Curves (cont.)



### 3-Lead TO-92 Package Outline (N3)



| Symbol                 |     | A    | b                 | c                 | D    | E    | E1   | e    | e1   | L     |
|------------------------|-----|------|-------------------|-------------------|------|------|------|------|------|-------|
| Dimensions<br>(inches) | MIN | .170 | .014 <sup>†</sup> | .014 <sup>†</sup> | .175 | .125 | .080 | .095 | .045 | .500  |
|                        | NOM | -    | -                 | -                 | -    | -    | -    | -    | -    | -     |
|                        | MAX | .210 | .022 <sup>†</sup> | .022 <sup>†</sup> | .205 | .165 | .105 | .105 | .055 | .610* |

JEDEC Registration TO-92.

\* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

**Drawings not to scale.**

**Supertex Doc.#:** DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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